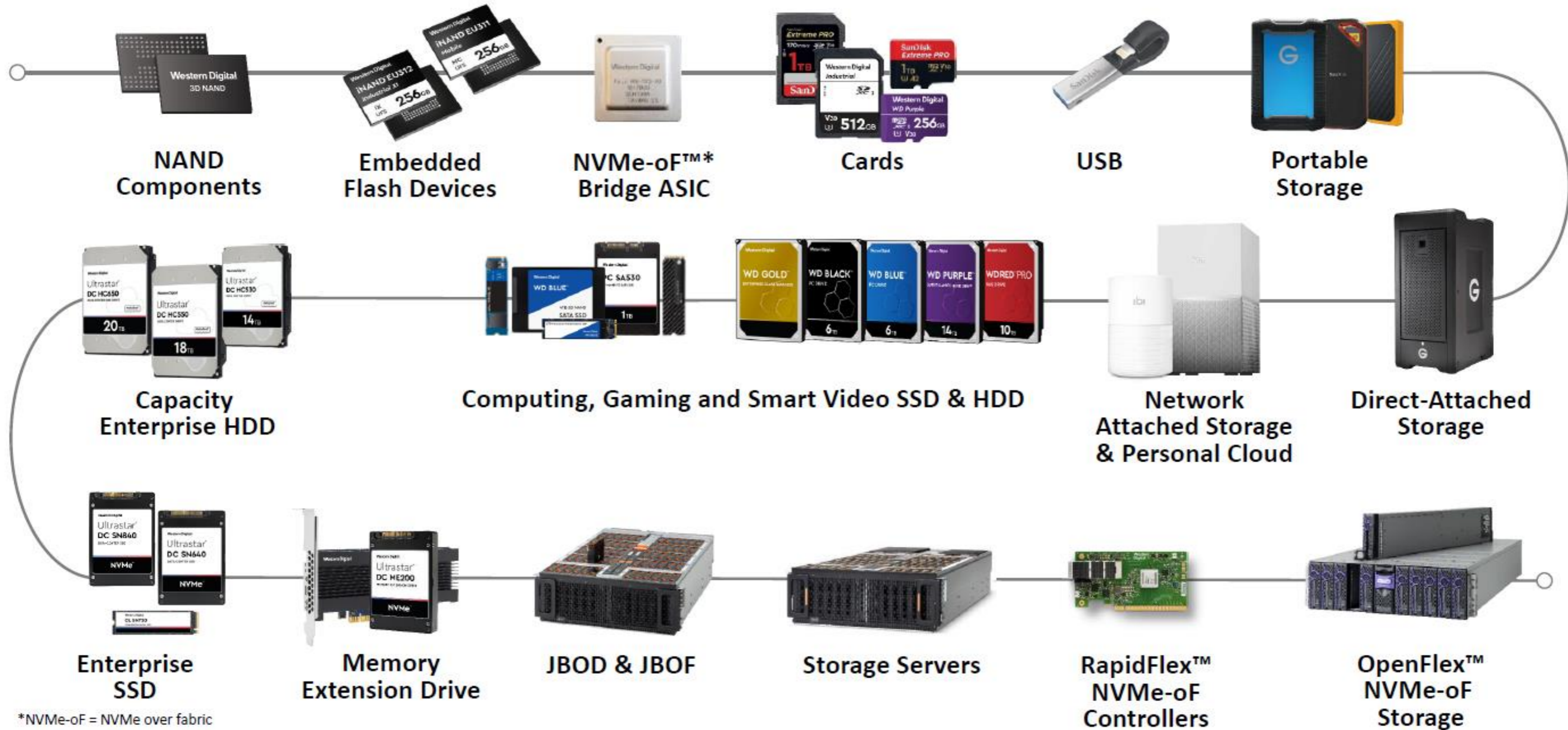


# Leading Portfolio Breadth and Depth

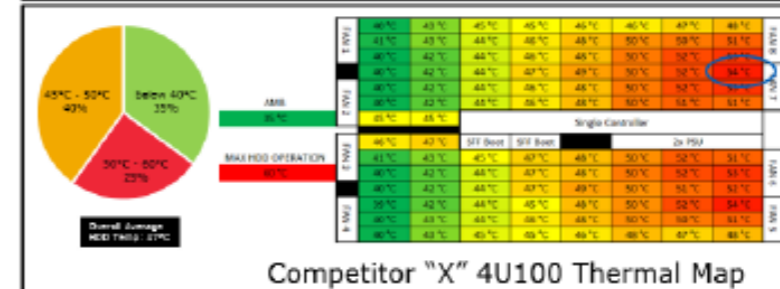
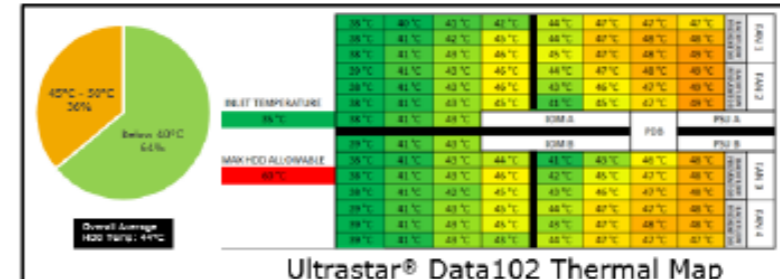
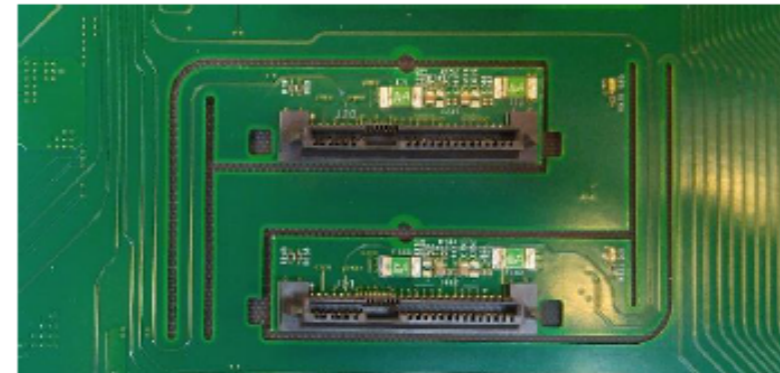
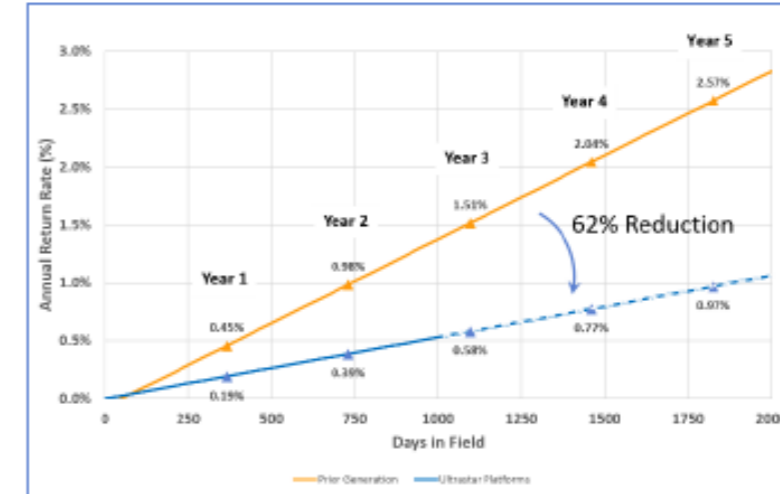
Solutions to capture, preserve, access and transform data



\*NVMe-oF = NVMe over fabric

# Ultrastar® Data Family Innovations

- Western Digital enclosures are different because we understand our devices and their interaction better than anyone
- Measured reduction of 62% in drive return rate\*
  - Same HDDs, vs. previous generation JBOD without IsoVibe & ArcticFlow
- IsoVibe patented vibration isolation technology
  - Vibration Isolated HDD carrier/slot & fans
  - Over 60% lower vibration
  - Performance is maintained, even when all the drives are working hard
- ArcticFlow thermal zone cooling technology
  - Lower temperatures, improved reliability, energy savings
  - Projected 13% fewer drive failures
  - \$1,500 in energy savings per enclosure
- Serviceability – maximizing “cold aisle” access
  - Rack mounted top cover
  - Top-load drives, tool-less carrier



\* Based on observed drive return data, does not change product specifications and does not constitute a warranty

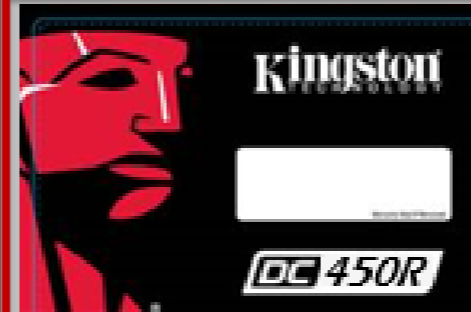
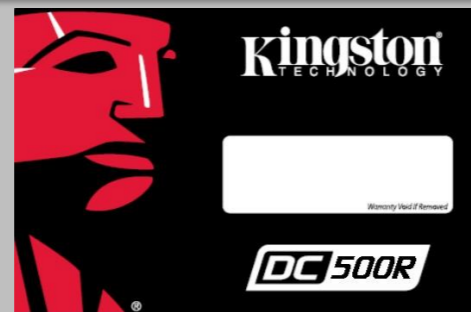
## SATA 2.5"

## SATA 2.5"

## SATA 2.5"

## NVMe U.2

## NVMe M.2



|                 | DC500R<br>(Read-Centric)                                   | DC500M<br>(Mixed Use)                                       | DC450R<br>(Entry Level)  | DC1000M<br>(Mixed Use)                     | DC1000B<br>(M.2 NVMe Boot)                                 |
|-----------------|--|---|--|--|--|
| Status          | Shipping   | Shipping  | Shipping   | Shipping                                   | Shipping   |
| Capacities      | 480GB – 7.68TB   | 480GB – 3.84TB  | 480GB – 7.68TB   | 960GB – 7.68TB                             | 240GB & 480GB<br>(960G Q3'20)                              |
| 128K Seq R/W *  | 555 MB/s<br>525 MB/s                                       | 555 MB/s<br>520 MB/s  | 560 MB/s<br>530 MB/s   | 3100 MB/s<br>2800 MB/s                     | 3200 MB/s<br>565 MB/s                                      |
| Form Factor     | 2.5" SATA III 6Gbps  | 2.5" SATA III 6Gbps   | 2.5" SATA III 6Gbps  | U.2 NVMe                                   | M.2 2280 NVMe  |
| 4K Random R/W * | 98K/28K IOPS   | 98K/75K IOPS  | 98K/28K IOPS   | 540K/210K IOPS                             | 205K/20K IOPS  |
| Applications    | Web Server,<br>Streaming, Cloud, CDN                       | Database, OLTP, Cloud,<br>Caching Tier                      | Web Server,<br>Streaming, Cloud, CDN                                 | Database, OLTP, CDN<br>Cloud, Caching Tier | Server Boot  |
| Features        | .5 DWPD for 5 yrs<br>Hardware PLP<br>256bit AES Encryption | 1.3 DWPD for 5 yrs<br>Hardware PLP<br>256bit AES Encryption | .3 DWPD for 5 yrs<br><b>No</b> Hardware PLP<br>256bit AES Encryption | 1 DWPD for 5 yrs<br>Hardware PLP           | .5 DWPD for 5 yrs<br>Hardware PLP<br>256bit AES Encryption |
| Warranty        | 5 Years  | 5 Years   | 5 Years  | 5 Years                                    | 5 Years  |

# 16Gb DRAM TRANSITION



Beginning in Q4 2019, DRAM semiconductor suppliers began introducing the next generation high density DRAM for DDR4. Based on new wafer lithography (below 20nm), these new components double the storage density available, allowing higher capacity memory modules to be created.

Unfortunately, some legacy chipsets/processors from Intel have not been updated to support memory modules featuring these new chips. This will present a problem long-term for supporting customers with legacy platforms, as the DRAM suppliers begin to shift the majority of their DDR4 output to 16Gbit (Gigabit) density wafers.

| 8Gbit     | 16Gbit  |
|-----------|---------|
| 512Mb x16 | 1Gb x16 |
| 1Gb x8    | 2Gb x8  |
| 2Gb x4    | 4Gb x4  |

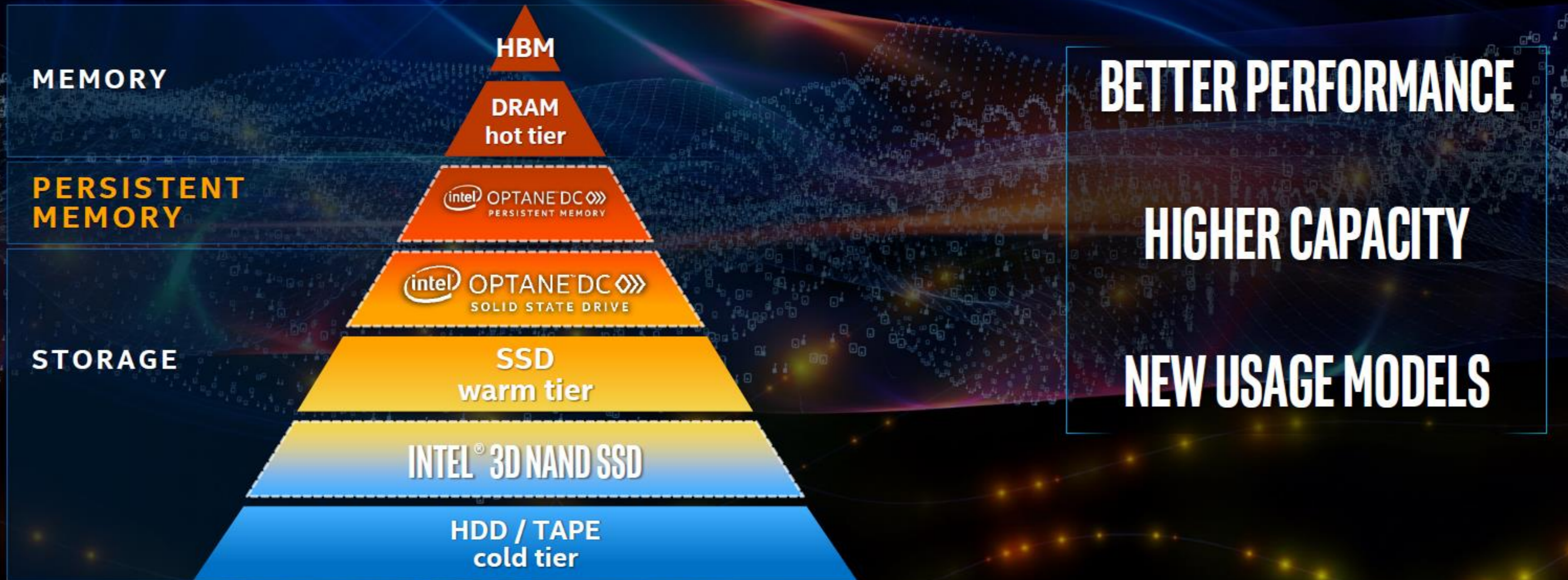


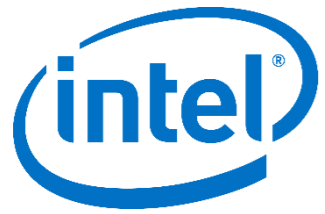
## **Module Types with 16Gb DRAM**

- 8GB Unbuffered DIMM / SODIMM (1Rx16)
- 16GB Unbuffered DIMM / SODIMM (1Rx8)
- 32GB Unbuffered DIMM / SODIMM (2Rx8)
- 16GB ECC Unbuffered DIMM / SODIMM (1Rx8)
- 32GB ECC Unbuffered DIMM / SODIMM (2Rx8)
- 16GB ECC Registered DIMM (1Rx8)
- 32GB ECC Registered DIMM (2Rx8)
- 32GB ECC Registered DIMM (1Rx4)
- 64GB ECC Registered DIMM (2Rx4)



# CONVERGING THE MEMORY / STORAGE HIERARCHY

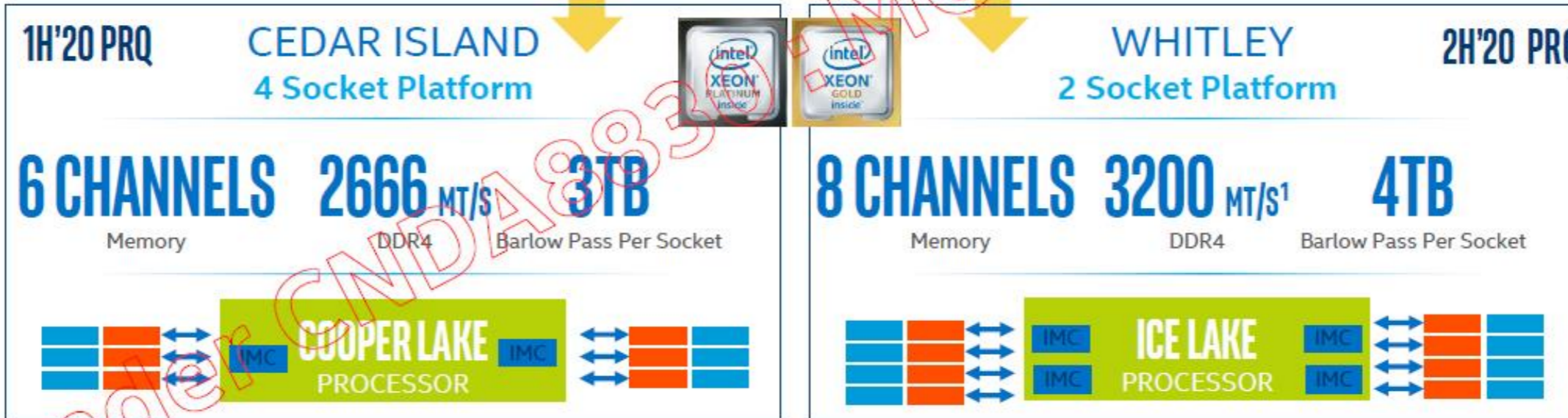




# NEW INTEL OPTANE PERSISTENT MEMORY 200 SERIES

## Intel Optane Persistent Memory 200 Series

UP TO **40% BANDWIDTH\*** Improvement vs Intel Optane persistent memory 100 series  
 UP TO **3200 MT/S** DDR4  
**15 WATTS** Thermal Design Power



## HIGHER MEMORY FREQUENCY AND BANDWIDTH, IMPROVED APP PERFORMANCE, OPTIMIZED THERMALS

1.MT/S is Million Transfers / Second. For Cedar Island, 2933 2DPC & 3200 1DPC is POR. Stretch target is 3200 2DPC  
 \*Many applications will benefit from higher memory frequency and bandwidth, those with bursty workloads can see an additional 20%-30% bandwidth increase using Intel Bandwidth boost, Applications whose OEMs implement eADR can see further application performance improvement



# Intel® Ethernet Network Adapter E810-CQDA1/CQDA2

Efficient workload-optimized performance at Ethernet speeds of 1 to 100Gbps

## Key Features

- Single and Dual-Port QSFP28
- PCI Express (PCIe) 4.0 x16
- Ethernet Port Configuration Tool (EPCT)

- Application Device Queues (ADQ)
- Dynamic Device Personalization (DDP)
- Supports both RDMA iWARP and RoCEv2

Improve application efficiency and network performance with innovative and versatile capabilities that optimize high-performance server workloads such as NFV, storage, HPC-AI and hybrid cloud.

## Performance for Cloud Applications

Delivers the bandwidth and increased application throughput required for demanding cloud workloads including edge services, web servers, database applications, caching servers, and storage targets.

- Application Device Queues (ADQ) improves application response time predictability using advanced traffic-steering technology
- Dynamic Device Personalization (DDP) enhances packet classification capabilities, to deliver up to 3x throughput improvement<sup>1</sup> for some cloud workloads
- Supports both RDMA iWARP and RoCEv2 for high-speed, low-latency connectivity to storage targets

## Optimizations for Communications Workloads

Provides packet classification and sorting optimizations for high-bandwidth network and communications workloads, including mobile core, 5G RAN, and network appliances.

- Dynamic Device Personalization (DDP) supports existing and new communications-specific protocols improving packet-processing efficiency up to 3x for some Network Functions Virtualization (NFV) workloads
- IEEE 1588 Precision Time Protocol (PTP) v2 enables precise clock synchronization across the 5G RAN deployments
- Enhanced Data Plane Development Kit (DPDK) support increases packet-processing speeds

## Versatile Port Configurations with EPCT

E810-CQDA1 and -CQDA2 adapters support a wide range of system configurations to meet customer needs and workload requirements. The many port and speed combinations available simplify validation and deployment.

Connect to a wide range of switch speeds and media types



Using EPCT, the Intel® Ethernet Network Adapter E810 (Dual or Single Port), can be programmed to act as many different physical network adapters, with a maximum throughput of 100Gbps

Intel® Ethernet 800 Series Network Adapters are designed with Intel® Ethernet Controller E810 and include these features<sup>2</sup>.



## Host Interface

- Compliance with PCIe 4.0
- Concurrency for 256 non-posted requests

## Software Interface

- Base mode VF compatibility with [Intel® Adaptive Virtual Functions Specification](#)
- Tx/Rx Queues
  - 2048 Tx queues and 2048 Rx queues
  - Dynamic allocation of queues to functions and VSIs
- Interrupts
  - 2048 Interrupts vectors, allocated in a flexible manner to queues and other causes
  - Multiple interrupt moderation schemes
  - 20M Interrupts/sec
- Control Queues (a.k.a. Admin Queues)
  - Mailbox Queues for PF-VF and driver-driver
  - Admin Queues for Software-Firmware control flows
  - Sideband Queues for Software to access IPs inside the E810
- 256 Tx Doorbell (DB) Queues
- 512 Tx Completion Queues
- Quanta Descriptor (QD) Queue per Tx queue. Quanta information is also embedded in the Tx doorbell
- Programmable Rx descriptor fields

## Packet Processing

- Enhanced Data Plane Development Kit (DPDK)
- General
  - Stages of parsing, switching, ACLs, classification, packet modification
  - Programmable packet processing pipeline
  - Profile based
  - Programmable actions
  - Propagation of priorities between stages
- Parser
  - Parses up to 6048 from packet header
  - Parse Graph based
  - Session-based parsing
  - Programmable parse engine
- Binary Classifier (VEB Switch)
  - 768 switch ports (VSIs)
  - Programmable forwarding rules
  - Storm Control

## ACLs

- 8K programmable TCAM entries
- Tiling capability to n\*40b width
- Classification Filters
  - Hash-based statistical distribution
  - Intel® Ethernet Flow Director (Intel® Ethernet FD) flow-based classification
  - Flow-based identification of iWARP and RoCE flows
  - Programmable rules
- Modifier
  - Insert (Tx), remove (Rx), and modify of packet VLANs
  - L3 and L4 checksums and CRC

## Virtualization

- Host virtualization via VMDQ and SR-IOV
- Up to 256 SR-IOV Virtual Functions
- Stateless offloads for tunneled packets (network virtualization support)
- Malicious VF protection
- Virtual machine load balancing (VMLB)
- Advanced packet filtering
- VLAN support with VLAN tag insertion, stripping and packet filtering for up to 4096 VLAN tags
- VxLAN, GENEVE, NVGRE, MPLS, VxLAN-GPE with Network Service Headers (NSH)
- Intel® Ethernet Adaptive Virtual Function drivers

## RDMA

- iWARP and RoCEv2
- 256K Queue Pairs (QPs)
- Send Queue Push Mode
- Note: RDMA is not supported when the E810 is configured for >4-port operation.*

## QoS

- WFQ Transmit scheduler with nine programmable layers
- Pipeline sharing and starvation avoidance
- QoS via 802.1p PCP or Differentiated Services Code Point (DSCP) value
- Packet shaping

## Manageability

- SMBus operating at up to 1Mb/s
- DMTF-compliant NC-SI 1.1 Interface at 100Mb/s
- MCTP over PCIe and SMBus
- Enterprise-level management schemes via local BMC
- SNMP and RMON statistic counters
- Watchdog timer
- PLDM over MCTP; PLDM Monitoring; PLDM firmware update; PLDM for RDE
- Firmware Management Protocol support

## Power Management

- Supports PCI power management states Do, D3hot, D3cold

## Time Synchronization

- Time stamp with each Rx packet
- Selective time stamps for Tx packets
- IEEE 1588 PTP v1 and v2 support
- Time synchronization signaling with other local platform ingredients

## Pre-Boot

- Signed UEFI option ROM compatible with HTTPS boot

## Security

- Hardware-based Root of Trust
- Authentication on NVM Read and Power On
- Built-in detection of firmware/critical setting corruption with automated device recovery